

TOSHIBA Transistor Silicon NPN·PNP Epitaxial Type  
(PCT process) (Bias Resistor built-in Transistor)

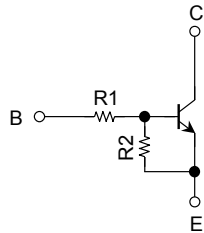
# RN47A4

Switching, Inverter Circuit, Interface Circuit and  
Driver Circuit Applications

- Two devices are incorporated into an Ultra-Super-Mini (5 pin) package.
- Incorporating a bias resistor into a transistor reduces parts count.  
Reducing the parts count enables the manufacture of ever more compact equipment and lowers assembly cost.

## Equivalent Circuit and Bias Resistor Values

**Q1**



Q1

R1: 47 kΩ, R2: 47 kΩ

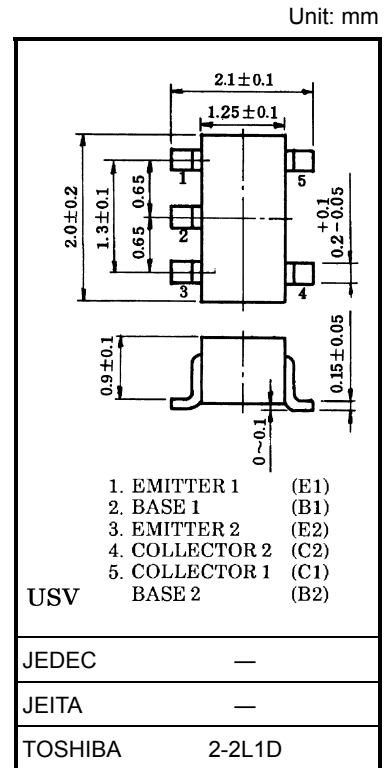
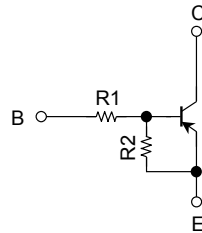
Q2

R1: 10 kΩ, R2: 47 kΩ

Q1: RN1104F

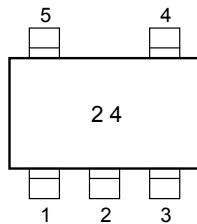
Q2: RN2107F

**Q2**

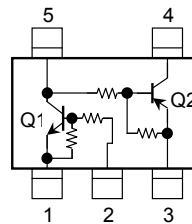


Weight: 0.0062g (typ.)

## Marking



## Equivalent Circuit (top view)



**Maximum Ratings (Ta = 25°C) (Q1)**

Characteristics	Symbol	Rating	Unit
Collector-base voltage	V <sub>CB0</sub>	50	V
Collector-emitter voltage	V <sub>CE0</sub>	50	V
Emitter-base voltage	V <sub>EB0</sub>	10	V
Collector current	I <sub>C</sub>	100	mA

**Maximum Ratings (Ta = 25°C) (Q2)**

Characteristics	Symbol	Rating	Unit
Collector-base voltage	V <sub>CB0</sub>	-50	V
Collector-emitter voltage	V <sub>CE0</sub>	-50	V
Emitter-base voltage	V <sub>EB0</sub>	-6	V
Collector current	I <sub>C</sub>	-100	mA

**Maximum Ratings (Ta = 25°C) (Q1, Q2 common)**

Characteristics	Symbol	Rating	Unit
Collector power dissipation	P <sub>C</sub> (Note)	200	mW
Junction temperature	T <sub>j</sub>	150	°C
Storage temperature range	T <sub>stg</sub>	-55~150	°C

Note: Total rating

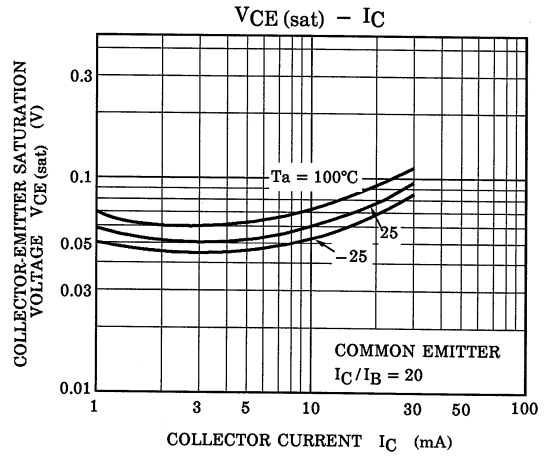
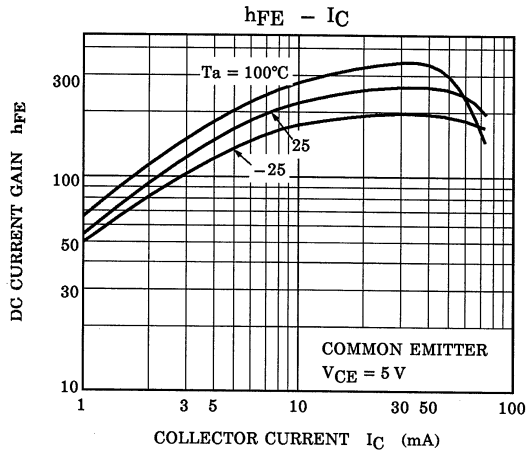
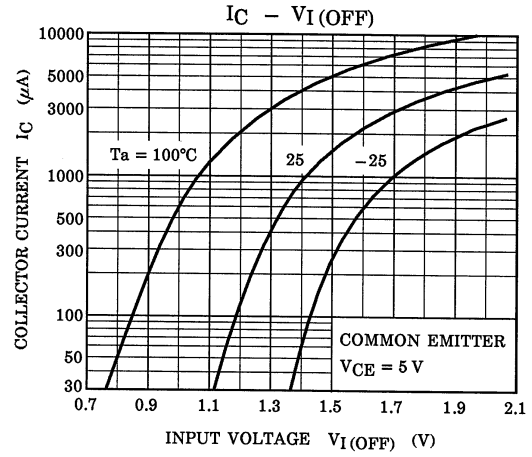
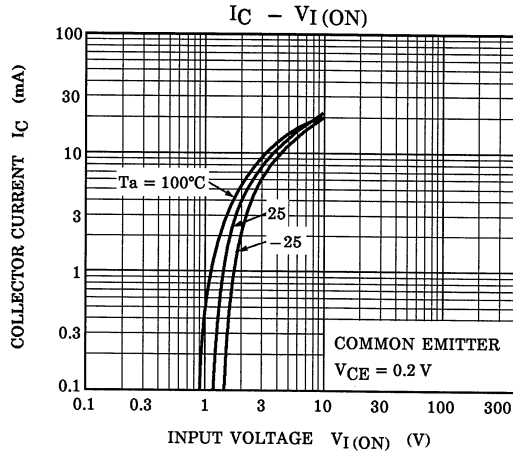
**Electrical Characteristics (Ta = 25°C) (Q1)**

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Collector cut-off current	$I_{CBO}$	$V_{CB} = 50\text{ V}, I_E = 0$	—	—	100	nA
	$I_{CEO}$	$V_{CE} = 50\text{ V}, I_B = 0$	—	—	500	
Emitter cut-off current	$I_{EBO}$	$V_{EB} = 10\text{ V}, I_C = 0$	0.082	—	0.15	mA
DC current gain	$h_{FE}$	$V_{CE} = 5\text{ V}, I_C = 10\text{ mA}$	80	—	—	
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C = 5\text{ mA}, I_B = 0.25\text{ mA}$	—	0.1	0.3	V
Input voltage (ON)	$V_{I(ON)}$	$V_{CE} = 0.2\text{ V}, I_C = 5\text{ mA}$	1.5	—	5.0	V
Input voltage (OFF)	$V_{I(OFF)}$	$V_{CE} = 5\text{ V}, I_C = 0.1\text{ mA}$	1.0	—	1.5	V
Transition frequency	$f_T$	$V_{CE} = 10\text{ V}, I_C = 5\text{ mA}$	—	250	—	MHz
Collector output capacitance	$C_{ob}$	$V_{CB} = 10\text{ V}, I_E = 0, f = 1\text{ MHz}$	—	3	—	pF
Input resistor	R1	—	32.9	47	61.1	kΩ
Resistor ratio	R1/R2	—	0.8	1.0	1.2	

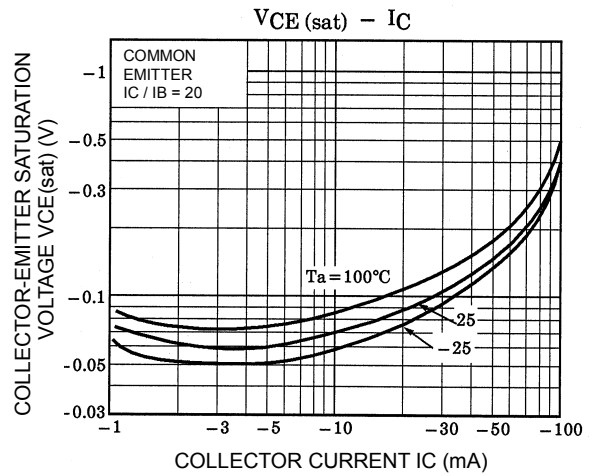
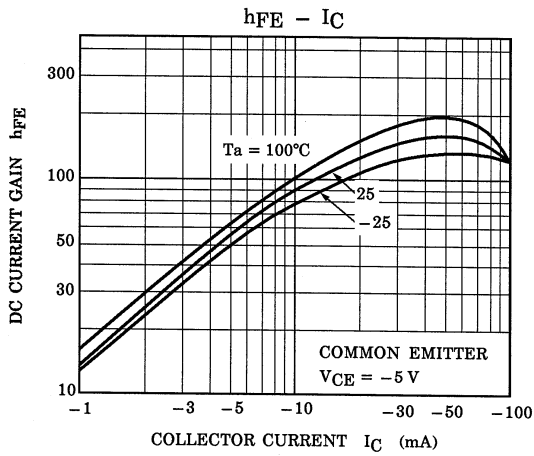
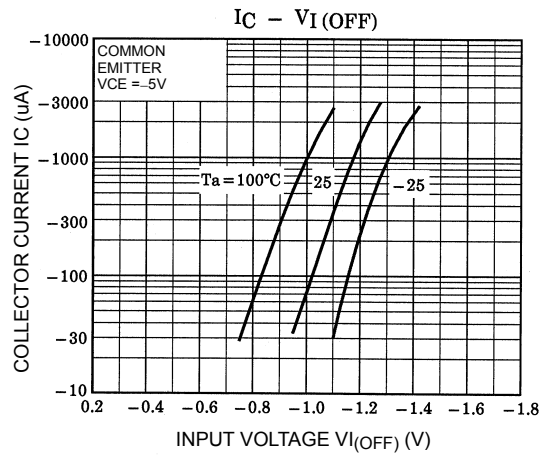
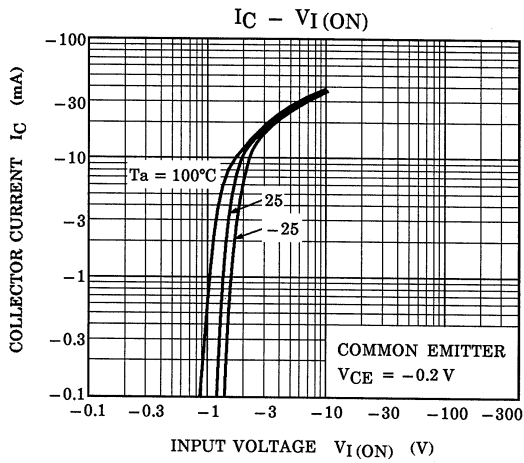
**Electrical Characteristics (Ta = 25°C) (Q2)**

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Collector cut-off current	$I_{CBO}$	$V_{CB} = -50\text{ V}, I_E = 0$	—	—	-100	nA
	$I_{CEO}$	$V_{CE} = -50\text{ V}, I_B = 0$	—	—	-500	
Emitter cut-off current	$I_{EBO}$	$V_{EB} = -6\text{ V}, I_C = 0$	-0.081	—	-0.15	mA
DC current gain	$h_{FE}$	$V_{CE} = -5\text{ V}, I_C = -10\text{ mA}$	80	—	—	
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C = -5\text{ mA}, I_B = -0.25\text{ mA}$	—	-0.1	-0.3	V
Input voltage (ON)	$V_{I(ON)}$	$V_{CE} = -0.2\text{ V}, I_C = -5\text{ mA}$	-0.7	—	-1.8	V
Input voltage (OFF)	$V_{I(OFF)}$	$V_{CE} = -5\text{ V}, I_C = -0.1\text{ mA}$	-0.5	—	-1.0	V
Transition frequency	$f_T$	$V_{CE} = -10\text{ V}, I_C = -5\text{ mA}$	—	200	—	MHz
Collector output capacitance	$C_{ob}$	$V_{CB} = -10\text{ V}, I_E = 0, f = 1\text{ MHz}$	—	3	—	pF
Input resistor	R1	—	7	10	13	kΩ
Resistor ratio	R1/R2	—	0.171	0.213	0.255	

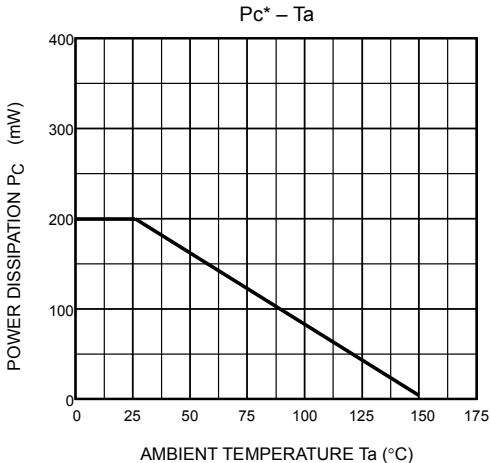
Q1



Q2



**Q1, Q2 Common**



\*:Total Rating

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